
2SJ332(L), 2SJ332(S)

Silicon P-Channel MOS FET

HITACHI

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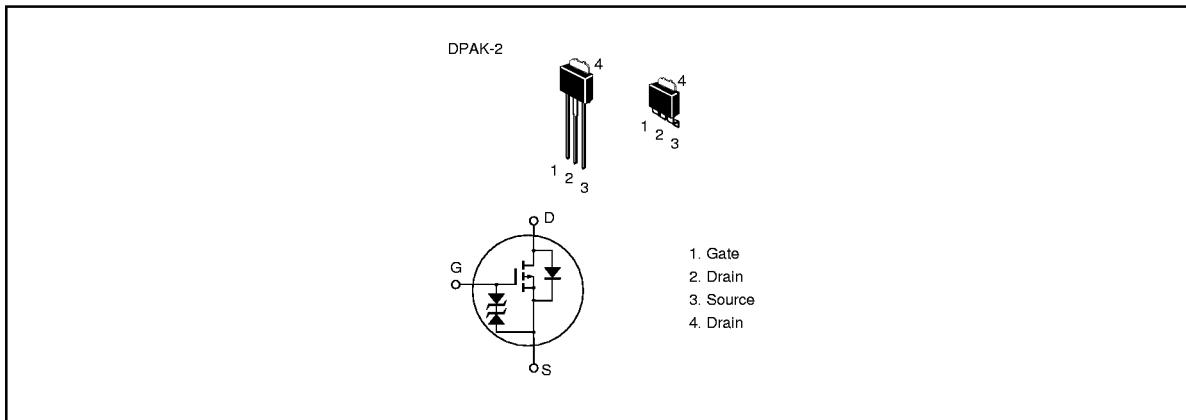
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC-DC converter

Outline



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Absolute Maximum Ratings (Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|---|-------------------------------------|----------------|-------------|
| Drain to source voltage | V _{DSS} | -20 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | I _D | -10 | A |
| Drain peak current | I _{D(pulse)} ^{*1} | -40 | A |
| Body to drain diode reverse drain current | I _{DR} | -10 | A |
| Channel dissipation | Pch ^{*2} | 20 | W |
| Channel temperature | T _{ch} | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |

Notes 1. PW ≤ 10 µs, duty cycle ≤ 1%

2. Value at T_c = 25°C

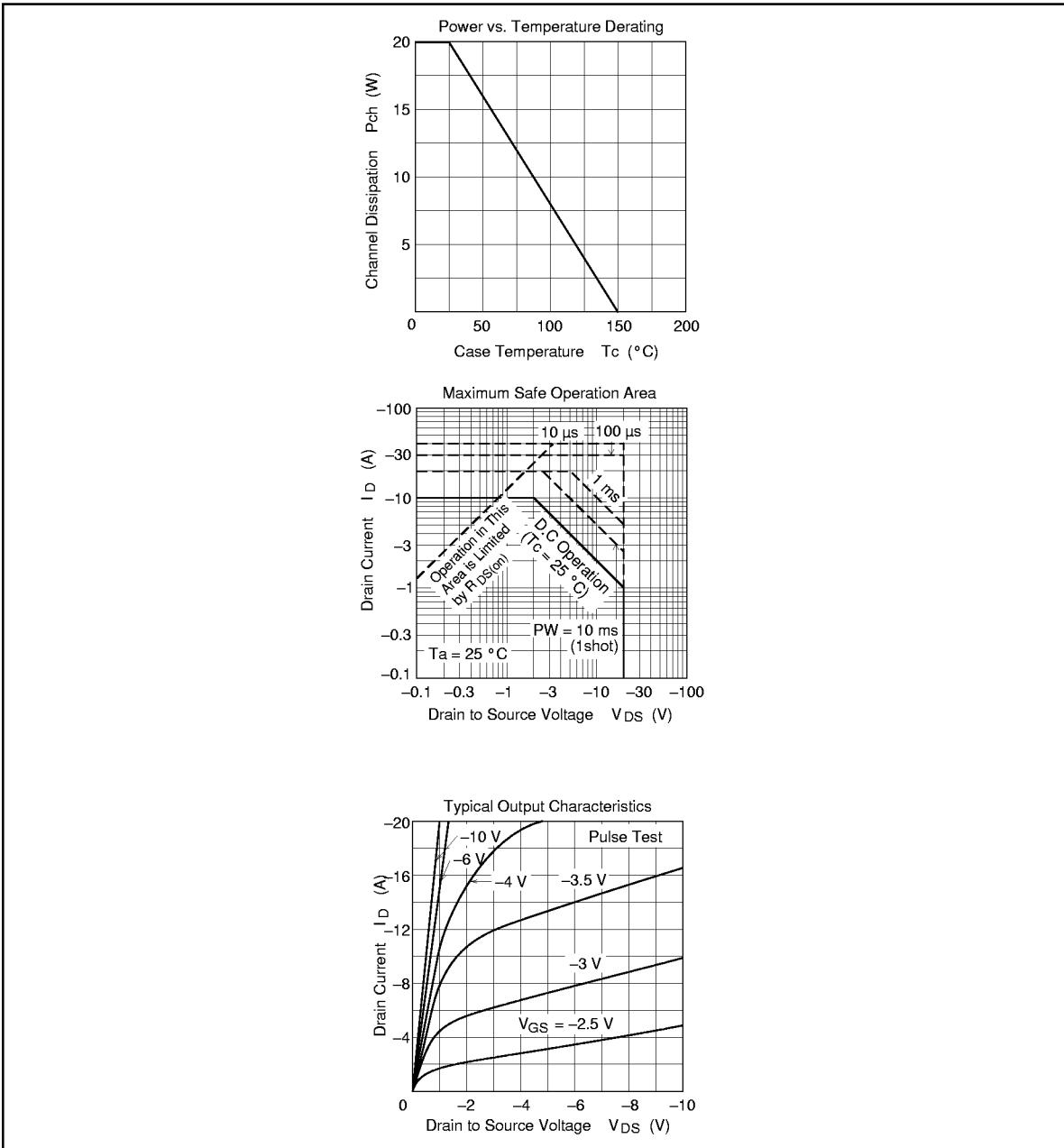
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Electrical Characteristics ($T_a = 25^\circ\text{C}$)

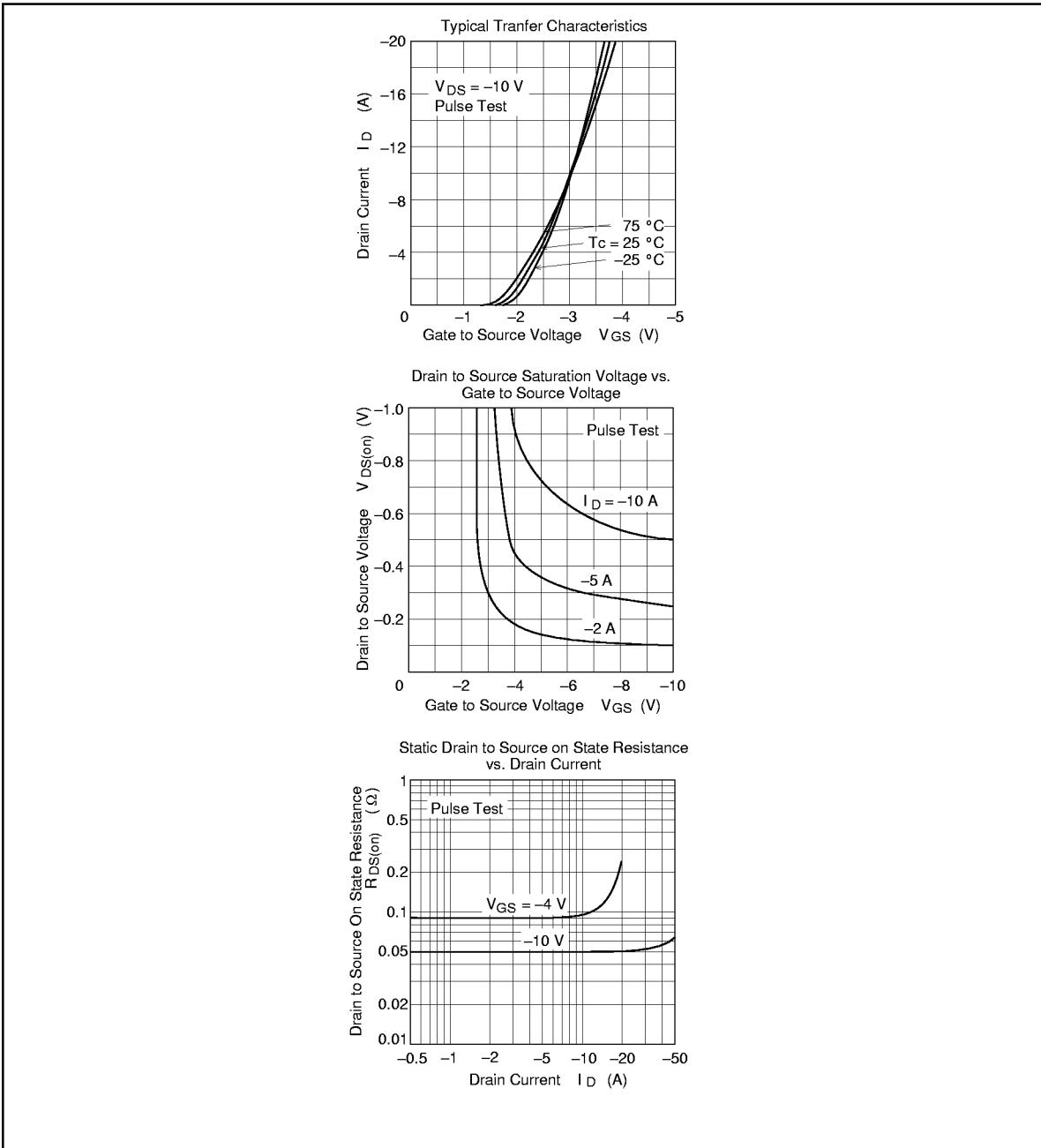
| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|--|-----------------------------|----------|------|----------|---------------|--|
| Drain to source breakdown voltage | $V_{(\text{BR})\text{DSS}}$ | -20 | — | — | V | $I_D = -10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(\text{BR})\text{GSS}}$ | ± 20 | — | — | V | $I_G = \pm 100 \mu\text{A}, V_{DS} = 0$ |
| Gate to source leak current | I_{GSS} | — | — | ± 10 | μA | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I_{DSS} | — | — | -100 | μA | $V_{DS} = -16 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(\text{off})}$ | -1.0 | — | -2.5 | V | $I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$ |
| Static drain to source on state resistance | $R_{D\text{(on)}}$ | — | 0.05 | 0.08 | Ω | $I_D = -5 \text{ A}, V_{GS} = -10 \text{ V}^*$ |
| | | — | 0.09 | 0.14 | Ω | $I_D = -5 \text{ A}, V_{GS} = -4 \text{ V}^*$ |
| Forward transfer admittance | $ y_{ls} $ | 6 | 9 | — | S | $I_D = -5 \text{ A}, V_{DS} = -10 \text{ V}^*$ |
| Input capacitance | C_{iss} | — | 730 | — | pF | $V_{DS} = -10 \text{ V}, V_{GS} = 0,$ $f = 1 \text{ MHz}$ |
| Output capacitance | C_{oss} | — | 680 | — | pF | |
| Reverse transfer capacitance | C_{rss} | — | 260 | — | pF | |
| Turn-on delay time | $t_{d(on)}$ | — | 13 | — | ns | $I_D = -5 \text{ A}, V_{GS} = -10 \text{ V},$ $R_L = 2 \Omega$ |
| Rise time | t_r | — | 110 | — | ns | |
| Turn-off delay time | $t_{d(off)}$ | — | 90 | — | ns | |
| Fall time | t_f | — | 110 | — | ns | |
| Body to drain diode forward voltage | V_{DF} | — | -1.2 | — | V | $I_F = -10 \text{ A}, V_{GS} = 0$ |
| Body to drain diode reverse recovery time | t_{rr} | — | 50 | — | μs | $I_F = -10 \text{ A}, V_{GS} = 0,$ $dI_F/dt = 50 \text{ A}/\mu\text{s}$ |

Note 1. Pulse test

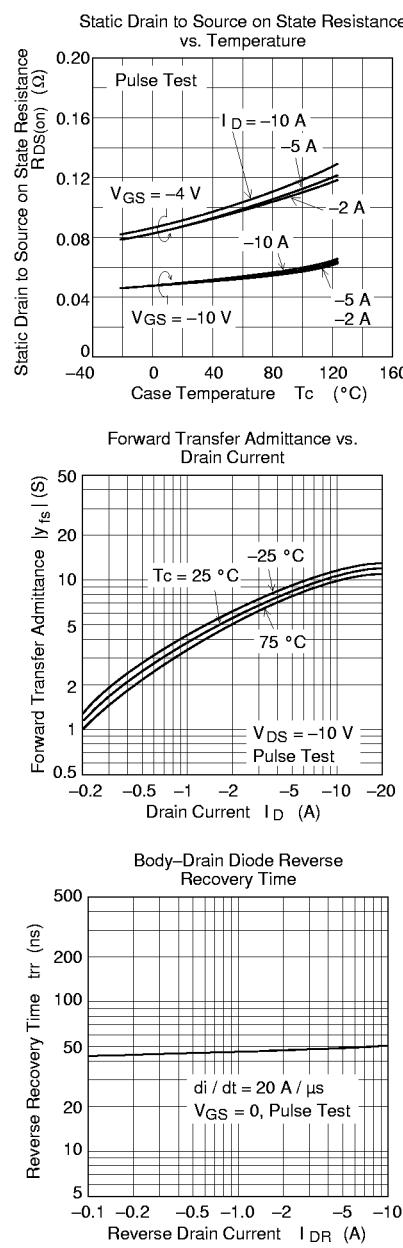
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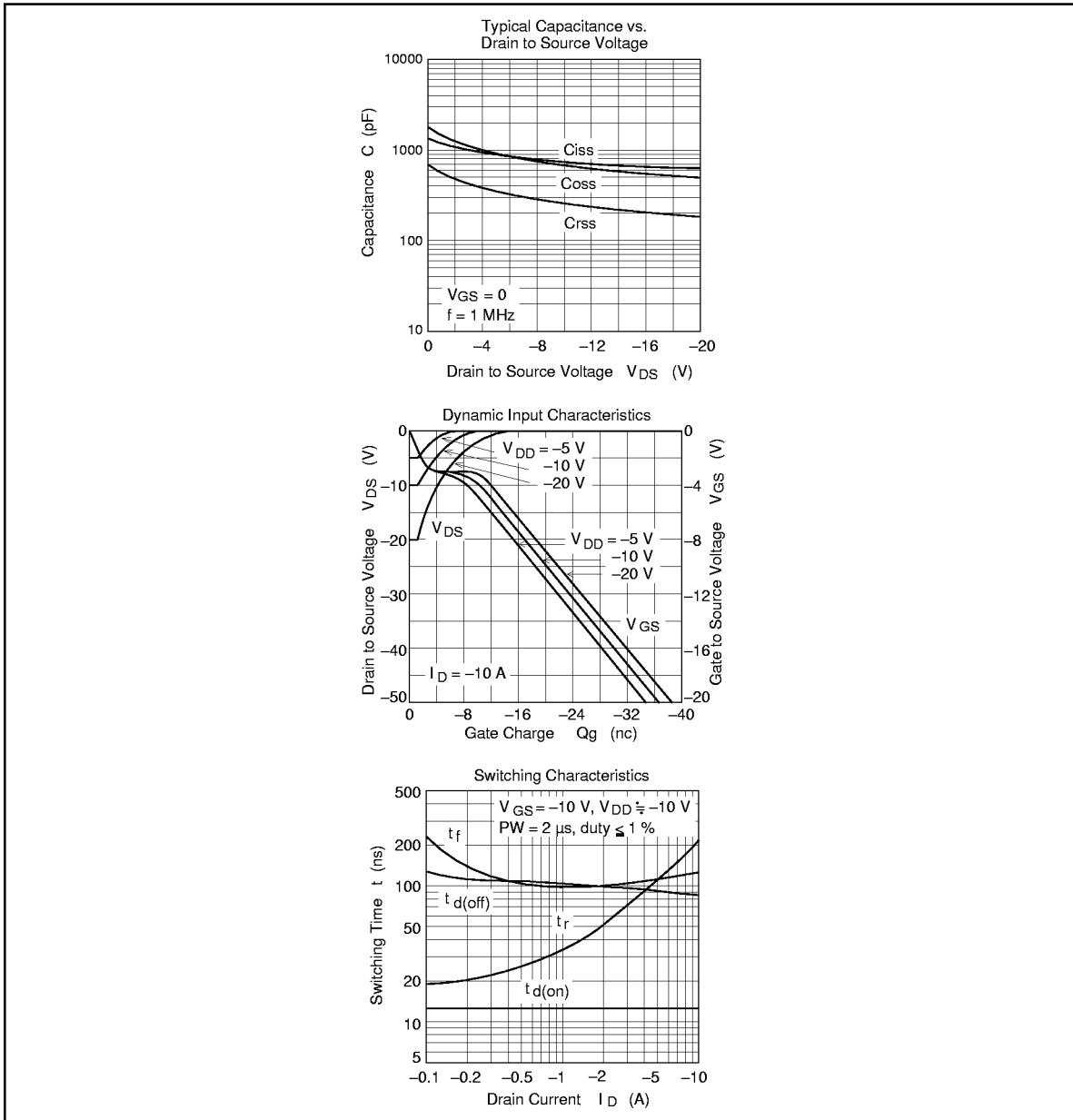
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